

IRF640NL-VB Datasheet

N-Channel 200-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{(BR)DSS} (V)	$\mathbf{R}_{DS(on)}$ (Ω) \mathbf{I}_{D} (A)		Q _g (Typ.)			
200	0.038 at V _{GS} = 15 V	45	57			
200	0.043 at V _{GS} = 10 V	40	57			

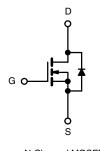
FEATURES

- Trench Power MOSFETS
- 175 °C Junction Temperature
- 100 % R_g and UIS Tested

APPLICATIONS

- Power Supply
- Lighting Systems





N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	$T_A = 25 ^{\circ}C$, unless oth	erwise noted			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	200	v		
Gate-Source Voltage	V _{GS}	± 25	v		
Continuous Drain Current ($T_1 = 175 ^{\circ}C$)	T _C = 25 °C	1-	45		
Continuous Drain Current $(1_j = 175 \text{ C})$	T _C = 100 °C	I _D	26	_	
Pulsed Drain Current	I _{DM}	150	A		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	20		
Single Pulse Avalanche Energy ^a	L = 0.11111	E _{AS}	20	mJ	
	T _C = 25 °C	Р	166 ^b	10/	
Maximum Power Dissipation ^a	T _A = 25 °C ^c	– P _D –	3.12	W	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS					
Parameter	Symbol	Limit	Unit		
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	40	°C/W		
Junction-to-Case (Drain)	R _{thJC}	0.75	- °C/W		

Notes:

a. Duty cycle \leq 1 %.

b. See SOA curve for voltage derating.

c. When Mounted on 1" square PCB (FR-4 material).



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	200			v	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2.5		4.5	v	
Gata Body Lookaga	I _{GSS}	V_{DS} = 0 V, V_{GS} = ± 20 V			± 100	nA	
Gate-Body Leakage		V_{DS} = 0 V, V_{GS} = ± 25 V			± 300		
		$V_{DS} = 200 \text{ V}, V_{GS} = 0 \text{ V}$			1	μΑ	
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = 200 V, V_{GS} = 0 V, T_{J} = 100 °C			25		
		V_{DS} = 200 V, V_{GS} = 0 V, T_{J} = 150 °C			250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 10$ V, $V_{GS} = 10$ V	40			А	
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		0.038		1	
Drain Source On State Desister	Base	$V_{GS} = 15 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		0.043		1	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V_{GS} = 10 V, I_D = 20 A, T_J = 100 °C		0.088		Ω	
		V_{GS} = 10 V, I_D = 20 A, T_J = 150 °C		0.120			
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 20 A	25	1		S	
Dynamie ^{to}	·			•			
Input Capacitance	C _{iss}			3100		pF	
Output Capacitance	C _{oss}	V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz		300			
Reverse Transfer Capacitance	C _{rss}			135			
Tatal Cata Charge ^C	V _{DS} = 100 V. V _{CS} = 15 V. I _D = 50 A	$V_{DS} = 100 \text{ V}, V_{GS} = 15 \text{ V}, I_{D} = 50 \text{ A}$		85	127		
Total Gate Charge ^c				57	85	nC	
Gate-Source Charge ^c	Q _{gs}	V_{DS} = 100 V, V_{GS} = 10 V, I_{D} = 50 A		14		nC	
Gate-Drain Charge ^c	Q _{gd}			20			
Gate Resistance	R _g	f = 1 MHz		1.2	1.8	Ω	
Turn-On Delay Time ^c	t _{d(on)}			16	25		
Rise Time ^c	t _r	V_{DD} = 100 V, R_L = 2 Ω		170	260	ne	
Turn-Off Delay Time ^c	t _{d(off)}	$\rm I_D \cong 50$ A, $\rm V_{GEN}$ = 10 V, $\rm R_g$ = 1 Ω		27	42	ns -	
Fall Time ^c	t _f			9	18		
Source Drain Diorde Flatings sand Ofa	a ngere ristices						
Continuous Current	I _S				36		
Pulsed Current	I _{SM}			1	80	A	
Forward Voltage ^a	V _{SD}	I _F = 20 A, V _{GS} = 0 V		0.86	1.5	V	
Reverse Recovery Time	t _{rr}			116	175	ns	
Peak Reverse Recovery Current	I _{RM(REC)}			9	14	A	
Reverse Recovery Charge	Q _{rr}	I _F = 40 A, di/dt = 100 A/μs		0.53	0.8	μC	
Reverse Recovery Fall Time	t _a			84	-		
Reverse Recovery Rise Time	t _b			32		nS	

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

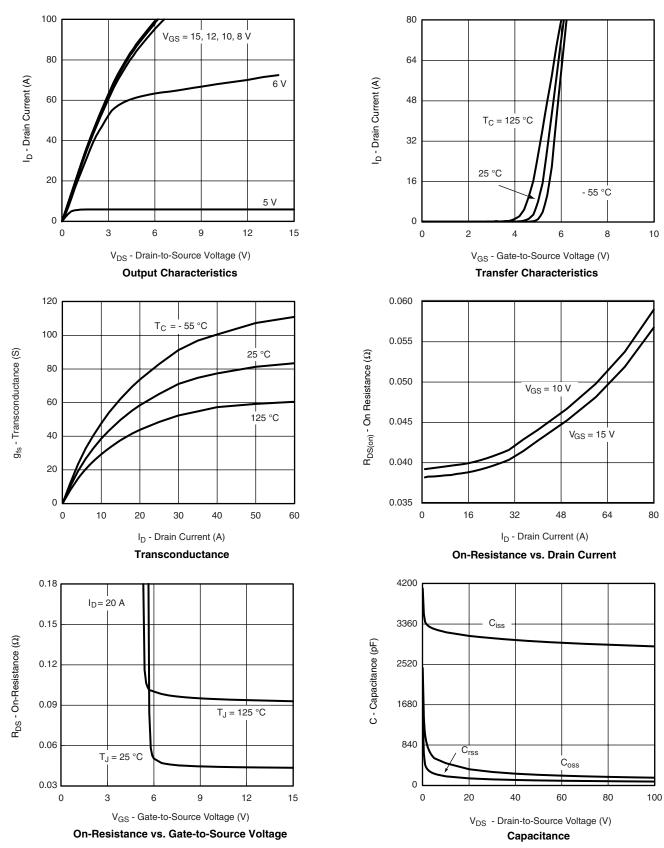
b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

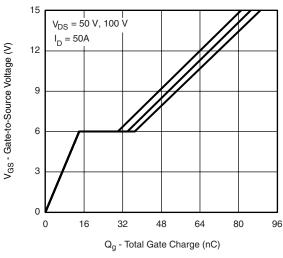




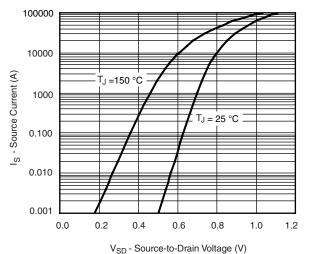


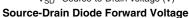


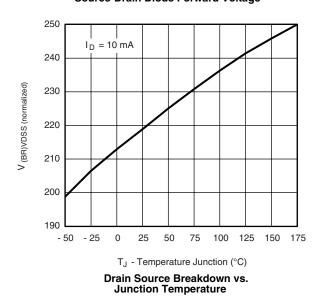


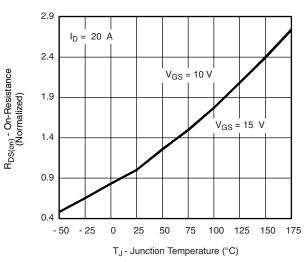




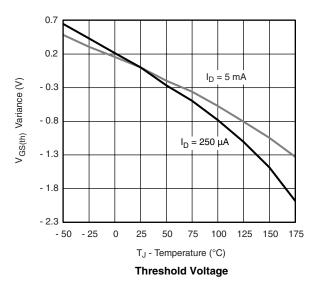


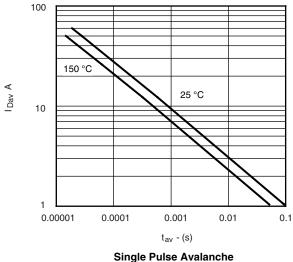






On-Resistance vs. Junction Temperature



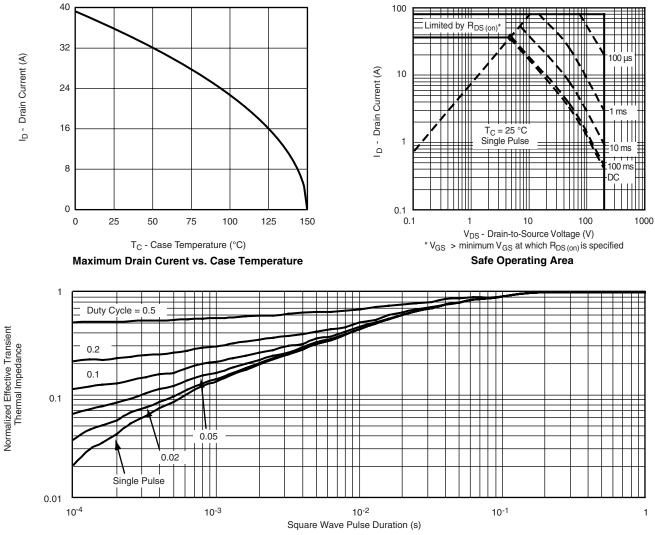


Current Capability vs. Time

IRF640NL-VB



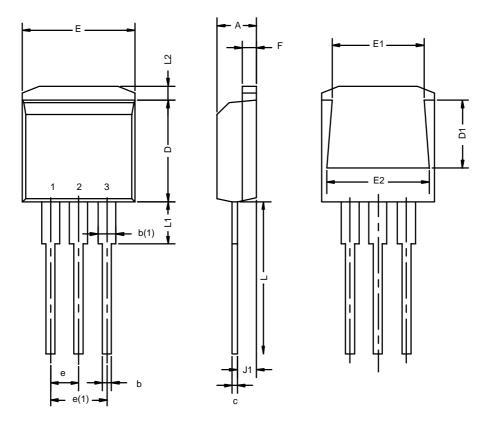
THERMAL RATINGS



Normalized Thermal Transient Impedance, Junction-to-Case



TO-262: 3-LEAD



	MILLIMETERS*		INCHES		
Dim	Min	Max	Min	Max	
Α	4.32	4.70	0.170	0.185	
b	0.64	1.00	0.025	0.039	
b(1)	1.14	1.40	0.045	0.055	
С	0.36	0.50	0.014	0.020	
D	8.64	9.65	0.340	0.380	
D1	5.59	6.10	0.220	0.240	
е	2.41	2.67	0.095	0.105	
e(1)	4.95	5.33	0.195	0.210	
Е	10.03	10.41	0.395	0.410	
E1	7.87	8.64	0.310	0.340	
E2	9.02	9.53	0.355	0.375	
F	1.14	1.40	0.045	0.055	
J1	2.41	2.79	0.095	0.110	
L	13.08	14.22	0.515	0.560	
L1	-	3.81	-	0.150	
L2	1.02	1.40	0.040	0.055	
ECN: T-02234—Rev. C, 14-Oct-02 DWG: 5855					

 $^{\ast}\mbox{Use}$ millimeters as the primary measurement



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